

# FS30ASJ-06F

High-Speed Switching Use  
Nch Power MOS FET

REJ03G0242-0100

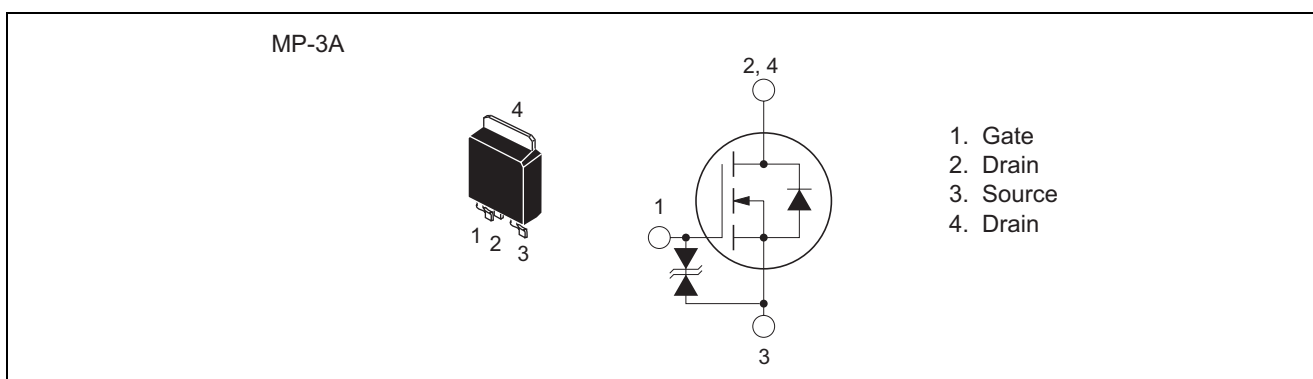
Rev.1.00

Aug.20.2004

## Features

- Drive voltage : 4 V
- $V_{DSS}$  : 60 V
- $r_{DS(ON) (max)}$  : 22 m $\Omega$
- $I_D$  : 30 A
- Recovery Time of the Integrated Fast Recovery Diode (TYP.) : 50 ns

## Outline



## Applications

Motor control, lamp control, solenoid control, DC-DC converters, etc.

## Maximum Ratings

(T<sub>c</sub> = 25°C)

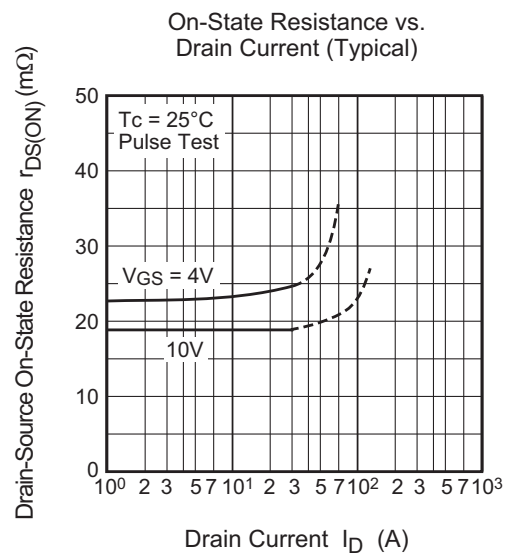
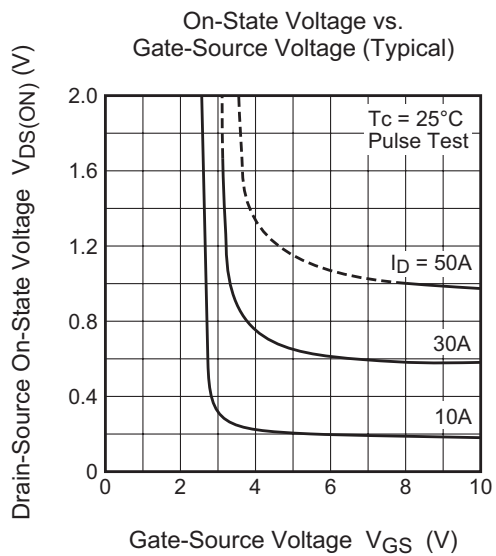
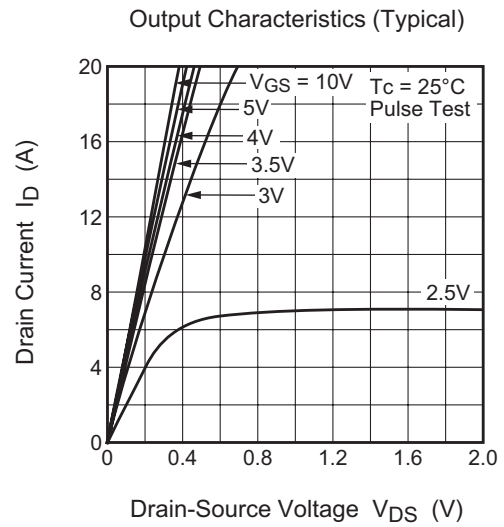
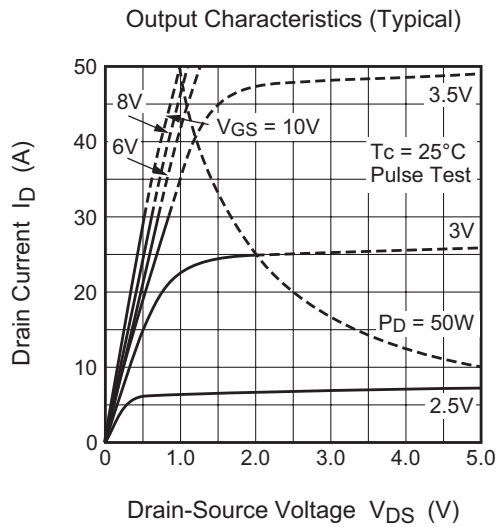
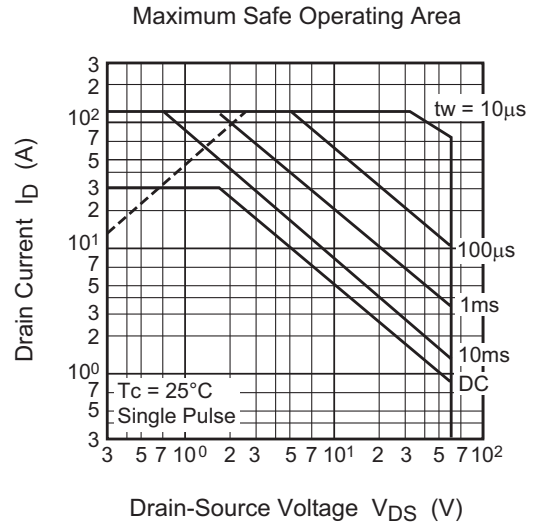
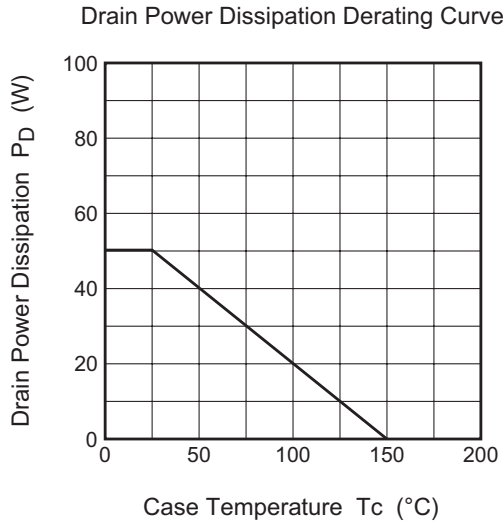
Parameter	Symbol	Ratings	Unit	Conditions
Drain-source voltage	$V_{DSS}$	60	V	$V_{GS} = 0$ V
Gate-source voltage	$V_{GSS}$	$\pm 20$	V	$V_{DS} = 0$ V
Drain current	$I_D$	30	A	
Drain current (Pulsed)	$I_{DM}$	120	A	
Avalanche current (Pulsed)	$I_{DA}$	30	A	L = 10 $\mu$ H
Source current	$I_S$	30	A	
Source current (Pulsed)	$I_{SM}$	120	A	
Maximum power dissipation	$P_D$	50	W	
Channel temperature	T <sub>ch</sub>	- 55 to +150	°C	
Storage temperature	T <sub>stg</sub>	- 55 to +150	°C	
Mass	—	0.32	g	Typical value

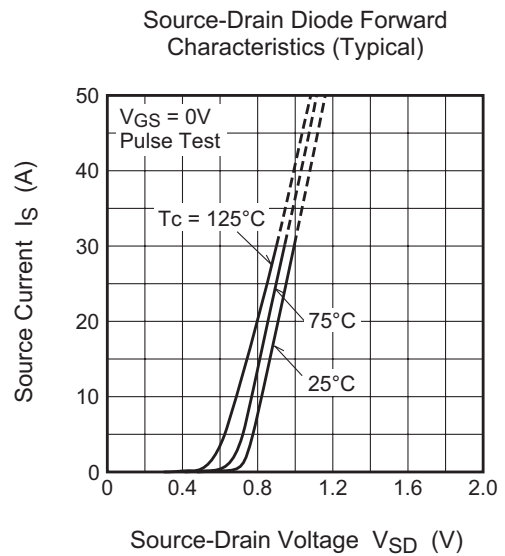
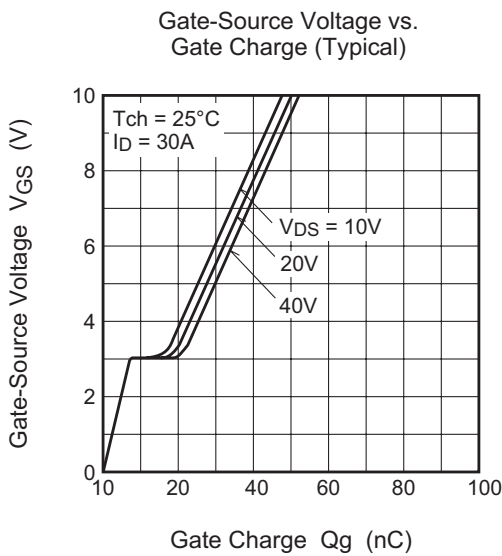
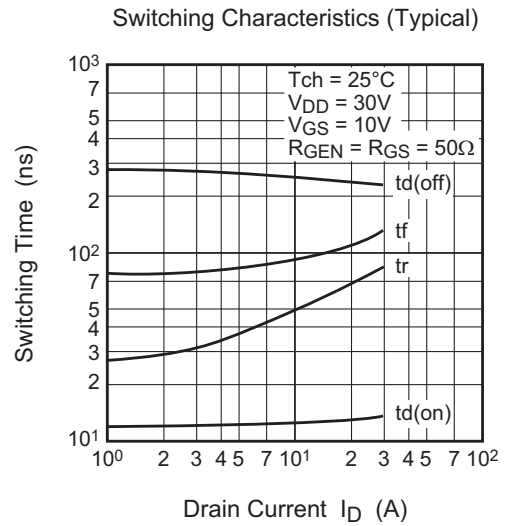
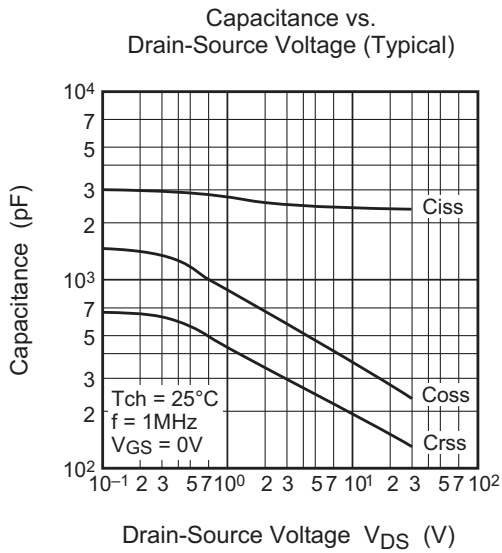
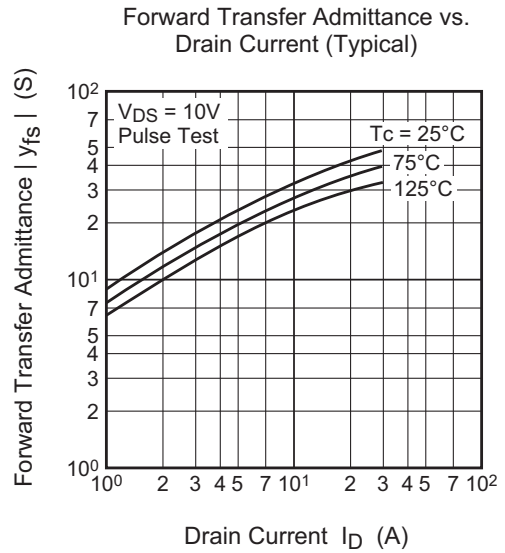
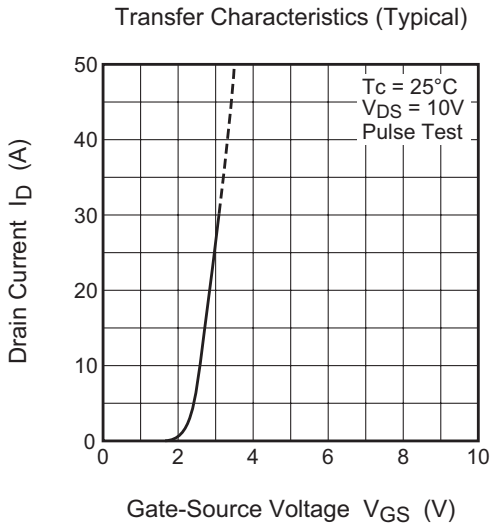
## Electrical Characteristics

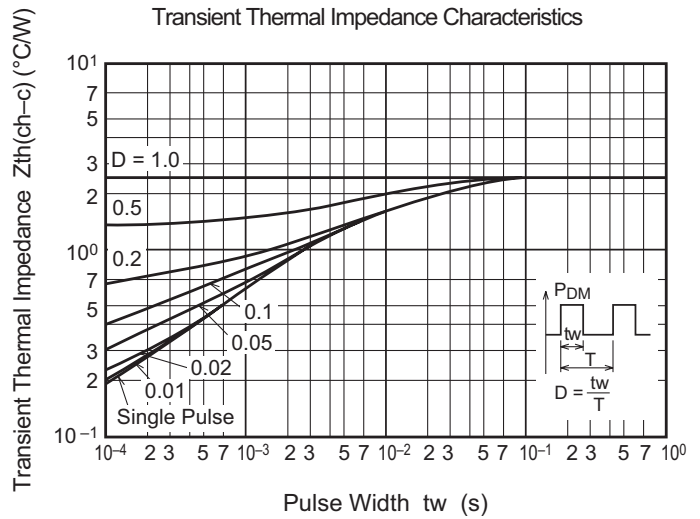
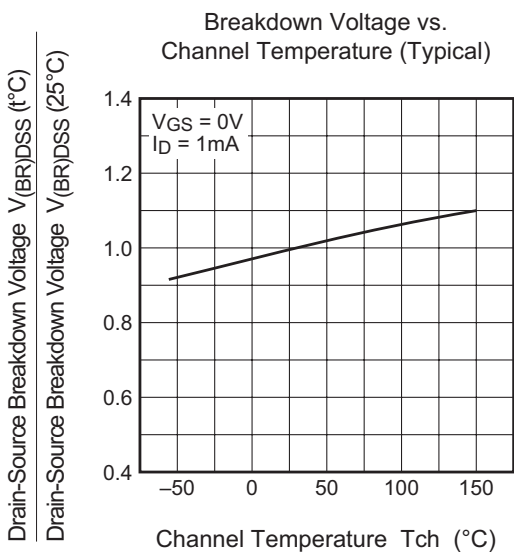
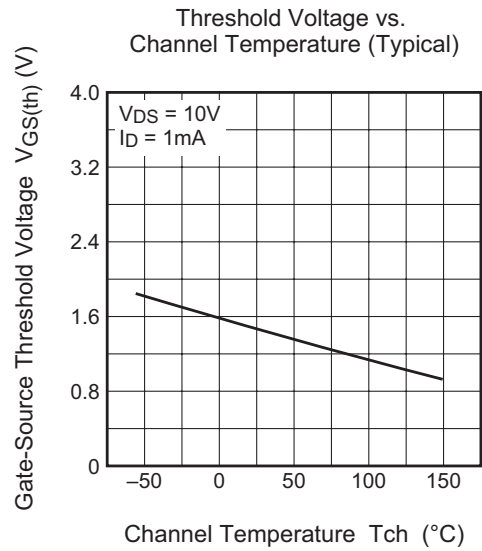
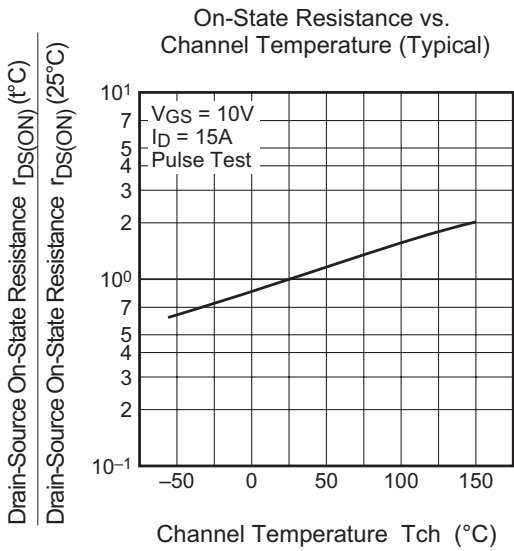
(T<sub>ch</sub> = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Drain-source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 1 \text{ mA}$ , $V_{GS} = 0 \text{ V}$
Gate-source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100 \text{ } \mu\text{A}$ , $V_{DS} = 0 \text{ V}$
Drain-source leakage current	$I_{DSS}$	—	—	100	μA	$V_{DS} = 60 \text{ V}$ , $V_{GS} = 0 \text{ V}$
Gate-source leakage current	$I_{GSS}$	—	—	±10	μA	$V_{GS} = \pm 20 \text{ V}$ , $V_{DS} = 0 \text{ V}$
Gate-source threshold voltage	$V_{GS(th)}$	1.0	1.5	2.0	V	$I_D = 1 \text{ mA}$ , $V_{DS} = 10 \text{ V}$
Drain-source on-state resistance	$r_{DS(ON)}$	—	18	22	mΩ	$I_D = 15 \text{ A}$ , $V_{GS} = 10 \text{ V}$
Drain-source on-state resistance	$r_{DS(ON)}$	—	22	28	mΩ	$I_D = 15 \text{ A}$ , $V_{GS} = 4 \text{ V}$
Drain-source on-state voltage	$V_{DS(ON)}$	—	0.27	0.33	V	$I_D = 15 \text{ A}$ , $V_{GS} = 10 \text{ V}$
Forward transfer admittance	$ y_{fs} $	—	38	—	S	$I_D = 15 \text{ A}$ , $V_{DS} = 10 \text{ V}$
Input capacitance	$C_{iss}$	—	2600	—	pF	$V_{DS} = 10 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1 \text{ MHz}$
Output capacitance	$C_{oss}$	—	385	—	pF	
Reverse transfer capacitance	$C_{rss}$	—	200	—	pF	
Turn-on delay time	$t_{d(on)}$	—	13	—	ns	$V_{DD} = 30 \text{ V}$ , $I_D = 15 \text{ A}$ , $V_{GS} = 10 \text{ V}$ , $R_{GEN} = R_{GS} = 50 \text{ } \Omega$
Rise time	$t_r$	—	45	—	ns	
Turn-off delay time	$t_{d(off)}$	—	240	—	ns	
Fall time	$t_f$	—	100	—	ns	
Source-drain voltage	$V_{SD}$	—	1.0	1.5	V	$I_S = 15 \text{ A}$ , $V_{GS} = 0 \text{ V}$
Thermal resistance	$R_{th(ch-c)}$	—	—	2.5	°C/W	Channel to case
Reverse recovery time	$t_{rr}$	—	50	—	ns	$I_S = 30 \text{ A}$ , $di/dt = -100 \text{ A}/\mu\text{s}$

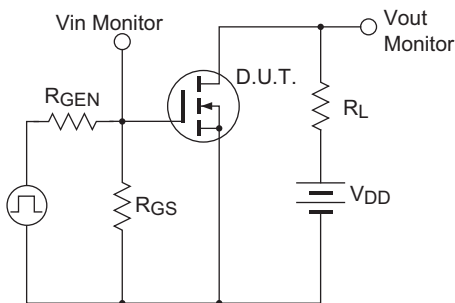
Performance Curves



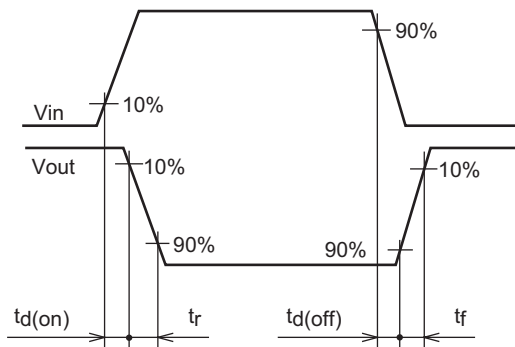




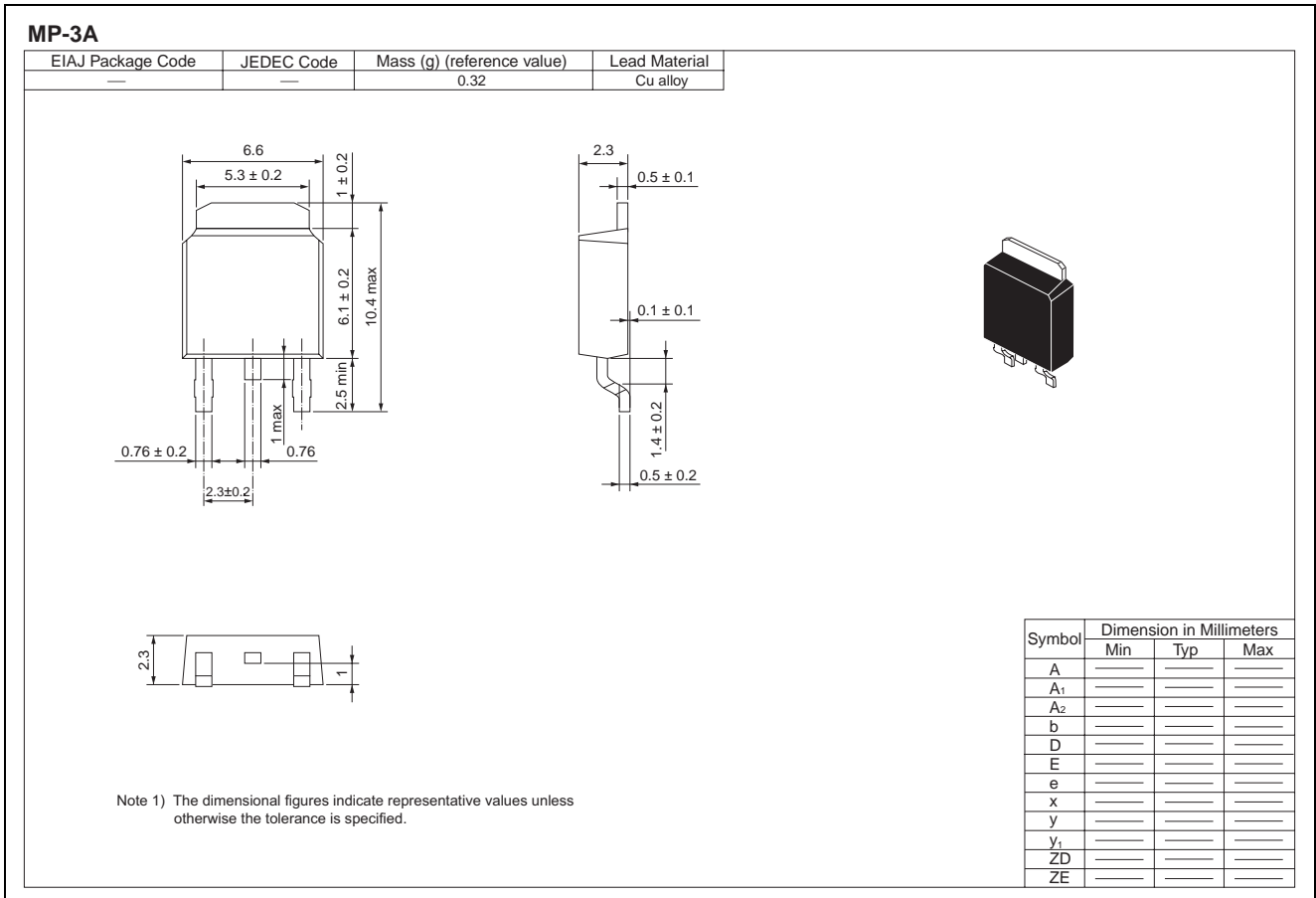
Switching Time Measurement Circuit



Switching Waveform



## Package Dimensions



## Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Surface-mounted type	Taping	3000	Type name – T +Direction (1 or 2) +3	FS30ASJ-06F-T13
Surface-mounted type	Plastic Magazine (Tube)	75	Type name	FS30ASJ-06F

Note : Please confirm the specification about the shipping in detail.

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